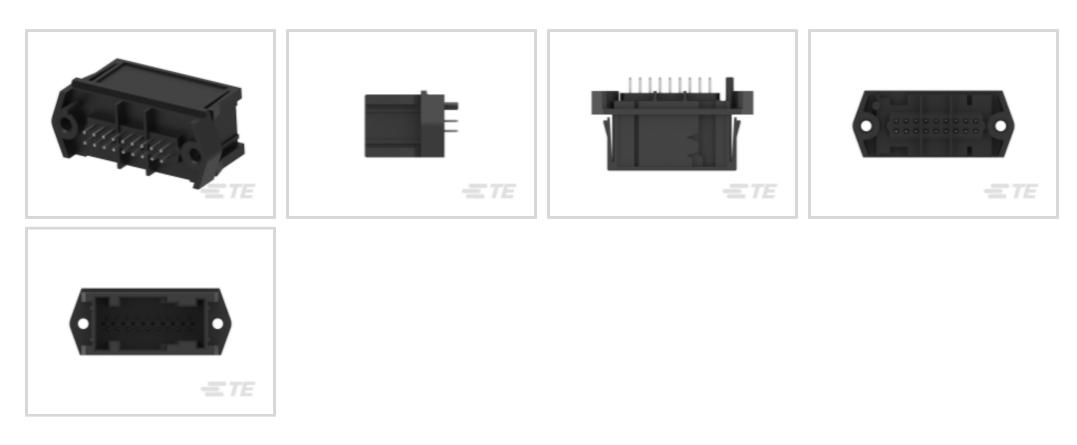


MQS

TE Internal #: 1-1355154-1 PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 2.54 mm [. 1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Black, Tray

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > Signal Header



Connector System: Wire-to-Board

Number of Positions: 18

Centerline (Pitch): 2.54 mm [.1 in]

Sealable: No

PCB Mount Orientation: Vertical

All Signal Header (299)

connectivity

Features

Product Type Features

Mixed & Hybrid Header	No
Connector Shape	Rectangular
PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Sections	1
Number of Signal Positions	18
Number of Positions	18
PCB Mount Orientation	Vertical
Number of Rows	2

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PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Black, Tray



Body Features

Primary Product Color	Black
Connector & Keying Code	A
Contact Features	
Contact Size	.63mm
Contact Type	Tab
Mating Tab Width	.63 mm[.025 in]
Mating Tab Thickness	.63 mm[.025 in]
Contact Mating Area Plating Material	Tin
Termination Features	
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mounting Holes	With
Mating Retention	With
Mating Alignment	With
PCB Mount Alignment	With
Panel Mount Feature	With
PCB Mount Retention	With
PCB Mount Retention Type	Mounting Hole
Mating Retention Type	Locking Interface
Connector Mounting Type	Panel Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Connector Length	41.3 mm[1.626 in]
Connector Width	23.8 mm[.937 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Profile Height from PCB	20.3 mm[.799 in]
Usage Conditions	
Operating Temperature (Max)	65 °C, 70 °C, 75 °C, 80 °C, 85 °C, 90 °C, 100 °C, 105 °C, 110 °C, 120 °C[149 °F][158 °F] [167 °F][176 °F][185 °F][194 °F][212 °F][221 ° F][230 °F][248 °F]

PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Black, Tray



Operating Temperature Range	-40 – 120 °C[-40 – 248 °F]
Operation/Application	
Shielded	No
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94HB
Packaging Features	
Packaging Quantity	384
Packaging Method	Tray
Other	
Interface Number	1355350
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUL 2021 (219) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not applicable for solder process capability

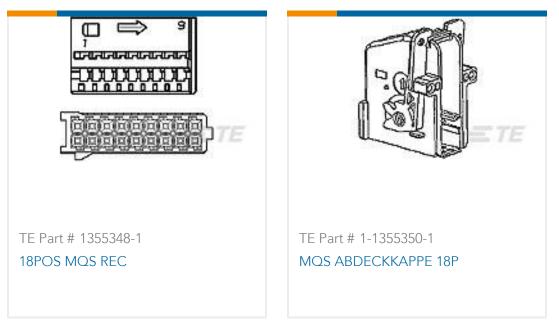
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Black, Tray

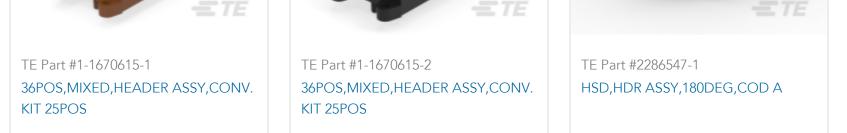






Customers Also Bought





Documents

Product Drawings MQS STIFTWANNE 18P

English

CAD Files

Customer View Model

ENG_CVM_CVM_1-1355154-1_B.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1355154-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1355154-1_B.3d_stp.zip

PCB Mount Header, Vertical, Wire-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Black, Tray



English

By downloading the CAD file I accept and agree to the $\ensuremath{\mathsf{Terms}}\xspace$ and $\ensuremath{\mathsf{Conditions}}\xspace$ of use.

Product Specifications Product Specification

English

Product Specification

English